

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yusuke OIKE</td> <td>03/06/2013</td> </tr> </tbody> </table>		Name	Execution Date	Yusuke OIKE	03/06/2013						
Name	Execution Date										
Yusuke OIKE	03/06/2013										
RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>SONY CORPORATION</td> </tr> <tr> <td>Street Address:</td> <td>1-7-1 Konan, Minato-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>Japan</td> </tr> <tr> <td>Postal Code:</td> <td>108-0075</td> </tr> </table>		Name:	SONY CORPORATION	Street Address:	1-7-1 Konan, Minato-ku	City:	Tokyo	State/Country:	Japan	Postal Code:	108-0075
Name:	SONY CORPORATION										
Street Address:	1-7-1 Konan, Minato-ku										
City:	Tokyo										
State/Country:	Japan										
Postal Code:	108-0075										
<table border="1"> <tr> <td>Name:</td> <td>THE BOARD OF TRUSTEES OF THE LELAND STANFORD JUNIOR UNIVERSITY</td> </tr> <tr> <td>Street Address:</td> <td>Stanford University, 1705 El Camino Real</td> </tr> <tr> <td>City:</td> <td>Palo Alto</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>94306</td> </tr> </table>		Name:	THE BOARD OF TRUSTEES OF THE LELAND STANFORD JUNIOR UNIVERSITY	Street Address:	Stanford University, 1705 El Camino Real	City:	Palo Alto	State/Country:	CALIFORNIA	Postal Code:	94306
Name:	THE BOARD OF TRUSTEES OF THE LELAND STANFORD JUNIOR UNIVERSITY										
Street Address:	Stanford University, 1705 El Camino Real										
City:	Palo Alto										
State/Country:	CALIFORNIA										
Postal Code:	94306										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13769471</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13769471						
Property Type	Number										
Application Number:	13769471										
CORRESPONDENCE DATA											
Fax Number:	7034132220										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	(703) 413-3000										
Email:	bpalmer@oblon.com										
Correspondent Name:	Oblon, Spivak, et al.										
Address Line 1:	1940 Duke Street										
Address Line 4:	Alexandria, VIRGINIA 22314										
ATTORNEY DOCKET NUMBER:	410831US8X										

OP \$40.00 13769471

NAME OF SUBMITTER:	Brian Palmer
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 1 source=410831USASSN#page1.tif	

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES

Title of
Invention

IMAGE SENSOR AND IMAGING METHOD WITH SINGLE SHOT COMPRESSED SENSING

As the below named inventor, I hereby declare that:

This declaration
are directed to:

The attached application, or

United States application or PCT international application number 13/769,471
filed on February 18, 2013

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, SONY CORPORATION, with offices at 1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN and THE BOARD OF TRUSTEES OF THE LELAND STANFORD JUNIOR UNIVERSITY with offices at STANFORD UNIVERSITY, 1705 El Camino Real, Palo Alto, CA 94306 (hereinafter referred to as ASSIGNEES), are desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or their designee, as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEES thereof shall hereafter require and prepare at their own expense;

And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

I hereby acknowledge that any willful false statement made in this declaration are punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF INVENTOR

Inventor: Yusuke OIKE

Date: March 6, 2013

Signature: *Yusuke Oike*

PATENT

RECORDED: 03/29/2013

REEL: 030114 FRAME: 0803